IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

ীন re Patent Application of

Tsutomu Saimoto et al.

Application No.: 10/506,806

Filed: September 7, 2004

For:

PRESSURE SENSITIVE ADHESIVE

FILM FOR PROTECTION OF SEMICONDUCTOR WAFER SURFACE AND METHOD OF PROTECTING SEMICONDUCTOR WAFER WITH THE PRESSURE SENSITIVE ADHESIVE FILM ) MAIL STOP AF

Group Art Unit: 2811

Examiner: Steven Ho Yin Loke

Confirmation No.: 5415

## AMENDMENT AND SUBMISSION OF TECHNICAL INFORMATION

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

In response to the Office Action mailed August 9, 2006, please amend the above-identified application as follows: